

TE Internal #: 6-2355626-1 DIMM Sockets, Double Data Rate (DDR) 5, Board-to-Component, 288 Position, Surface Mount Mount, Vertical Module Orientation View on TE.com >



Connectors > Socket Connectors > Memory Sockets > DIMM Sockets



DRAM Type: Double Data Rate (DDR) 5

Connector System: Board-to-Component

Number of Positions: 288

PCB Mounting Style: Surface Mount

Module Orientation: Vertical

Features

Product Type Features

DRAM Type	Double Data Rate (DDR) 5				
Connector System	Board-to-Component				
Connector & Contact Terminates To	Printed Circuit Board				
Configuration Features					
Number of Bays	2				
Number of Keys	1				
Number of Rows	2				
Number of Positions	288				
Module Orientation	Vertical				
Electrical Characteristics					
DRAM Voltage	1.1 V				
Body Features					
PCB Retention Feature Material	Stainless Steel				
Ejector Material Color	Black				
Ejector Material	High Temperature Nylon				

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Latch Color	Black
Ejector Location	Both Ends
Latch Material	High Temperature Nylon
Module Key Type	DRAM
Connector Profile	Standard
Ejector Type	Rotary
Contact Features	
Memory Socket Type	Memory Card
Socket Style	DIMM
PCB Contact Termination Area Plating Material Thickness	3 μm[120 μin]
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Mating Area Plating Material	Gold
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	1.5 A

Termination Features

Insertion Style	Direct Insert
Termination Post & Tail Length	.89 mm[.035 in]
Mechanical Attachment	
Mount Angle	Vertical
PCB Mount Alignment Type	None
Mating Alignment Type	1 Key
Mating Alignment	With
PCB Mount Retention Type	Tab
PCB Mounting Style	Surface Mount
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	High Temperature Nylon
Housing Color	Black
Centerline (Pitch)	.85 mm[.033 in]
Dimensions	

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Profile Height from PCB	21.3 mm[.083 in]
Row-to-Row Spacing	3 mm[.118 in]
Jsage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	High Speed Data
ndustry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	640
Packaging Method	Box & Tray

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant			
EU ELV Directive 2000/53/EC	Compliant			
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold			

EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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Compatible Parts

TE Part # 6-2355632-1 DDR5 DIMM NATURAL HSG AND NATURAL LATCH

Customers Also Bought



TE Part #2367197-4	TE Part #796136-5	TE Part #2312486-2	TE Part #3-6450861-0
1.0mm WTB Side Vertical Type With	ASSY, SMT BATTERY CONN	PCI EXP 2.3L 36 POS BLK 15u"	V/R, ASSY, PF,12S+2HDP+12LP
Latch			

TE Part #1-2336568-0 RECEPT ASSY, RA, 168 POS, SLIVER 2.0

Documents

Product Drawings DDR5 DIMM BLACK HSG AND BLACK LATCH

English

CAD Files

Customer View Model

ENG_CVM_CVM_6-2355626-1_A.2d_dxf.zip

English

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Customer View Model

ENG_CVM_CVM_6-2355626-1_A.3d_stp.zip

English

Customer View Model

ENG_CVM_CVM_6-2355626-1_A.3d_igs.zip

English

3D PDF

3D

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Application Specification

English

Product Environmental Compliance Product Compliance

English

Product Compliance

English